晶采光電科技股份有限公司
AMPIRE CO., LTD.

SPECIFICATIONS FOR
LCD MODULE

CUSTOMER	
CUSTOMER PART NO.	
AMPIRE PART NO.	**AC-242CYA**
APPROVED BY	
DATE	

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RECORD OF REVISION

Revision Date	Section	Contents
2000/10/7	-	New Release
2001/12/12		Modify LED characteristic

1 FEATURES

(1) Display format : 24 Characters × 2 Line , 1/16 duty.

(2) Construction : LCD, Bezel, Zebra and PCB.

(3) Display type : STN yellow-green type, Reflective, 6 o'clock, Positive.

(4) Controller : KS0066U.

(5) 5V single power input.

(6) Normal temperature type.

2 MECHANICAL DATA

Parameter	Stand Value	Unit
Character size	4.26(W) × 6.84(H)	mm
Character pitch	5.08(W) × 7.66(H)	mm
Viewing area	133.0(W) × 20.3(H)	mm
Module size	154.0(W) × 39.0(H) × 12.0 max (T)	mm

3 ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Logic Circuit Supply Voltage	VDD-VSS	-0.3	7.0	V
LCD Driving Voltage	VDD-VO	-0.3	10.0	V
Input Voltage	V_I	-0.3	VDD+0.3	V
Operating Temp.	T_{OP}	0	50	°C
Storage Temp.	T_{STG}	-20	70	°C

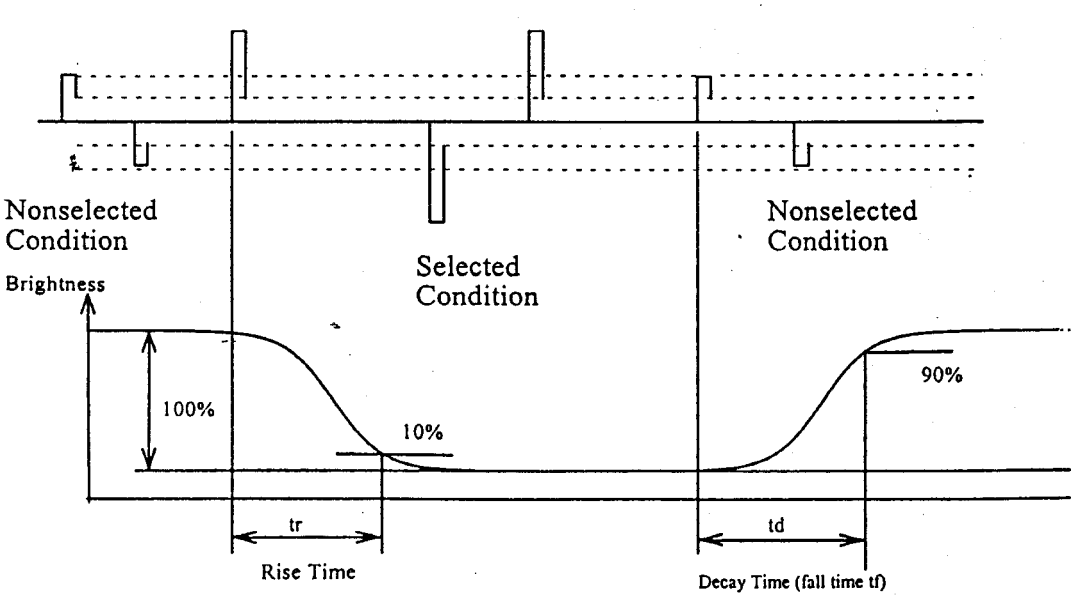
4 ELECTRO-OPTICAL CHARACTERISTICS

Parameter	Symbol	Condition	Min	Typ	Max	Unit	Note
----- Electronic Characteristics -----							
Logic Circuit Supply Voltage	VDD-VSS	--	4.5	5.0	5.5	V	
LCD Driving Voltage	VDD-VO	25 °C	--	4.2	--	V	
Input Voltage	VIH	--	0.7 VDD	--	VDD	V	
	VIL	--	VSS	--	0.3 VDD	V	
Logic Supply Current	IDD	VDD = 5V	--	1.3	--	mA	
----- Optical Characteristics -----							
Contrast	CR	--	--	5	--		Note 1
Rise Time	tr	25°C	--	200	300	ms	Note 2
Fall Time	tf	25°C	--	200	300	ms	
Viewing Angle Range	θ f	25°C & CR≥2	--	40	--	Deg.	Note 3
	θ b		--	35	--		
	θ l		--	35	--		
	θ r		--	35	--		
Frame Frequency	fF	25°C	--	64	--	Hz	

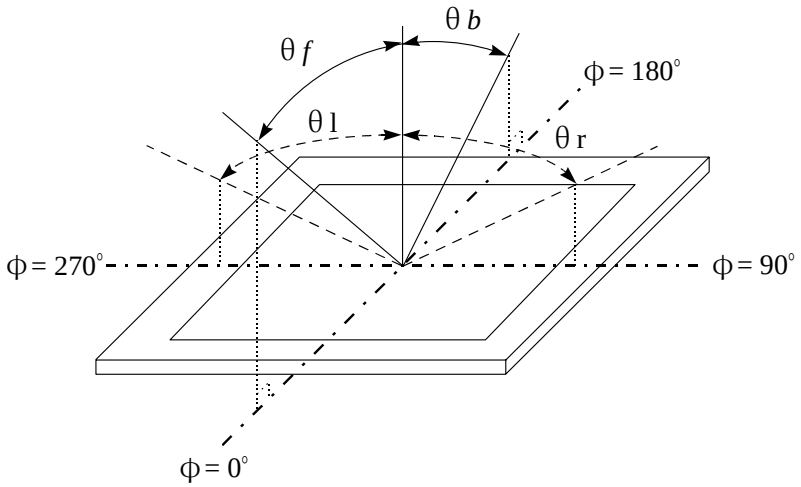
(NOTE 1) Contrast ratio :

CR = (Brightness in OFF state) / (Brightness in ON state)

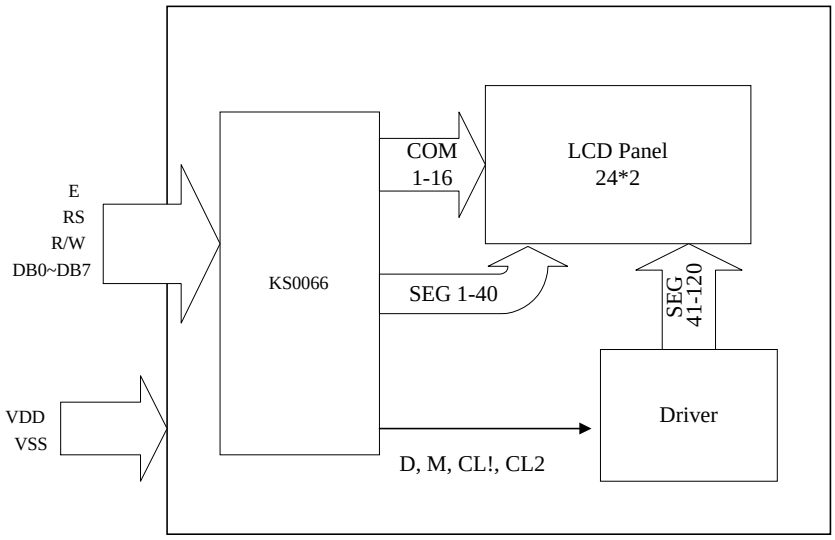
(NOTE 2) Response time :

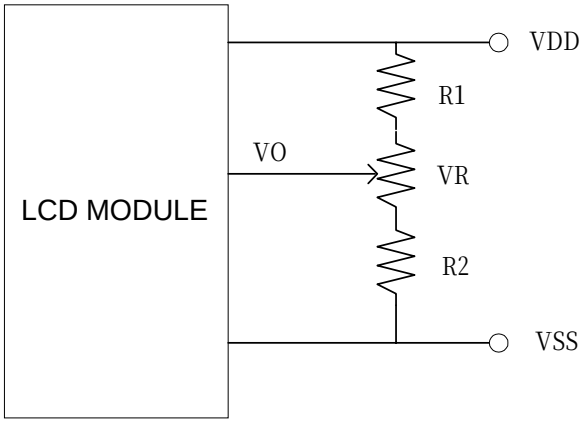


(NOTE 3) Viewing angle



5 BLOCK DIAGRAM & POWER SUPPLY



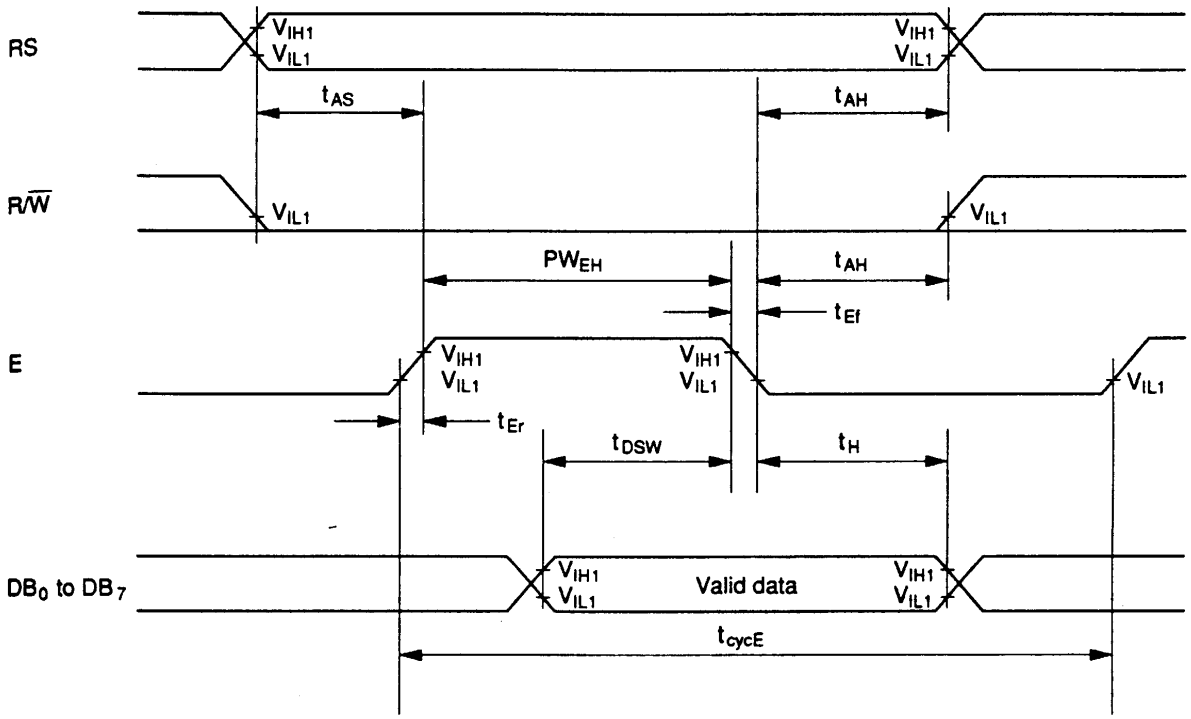


6 PIN CONNECTIONS

No.	Symbol	Function
1	VSS	Ground (0V)
2	VDD	Supply Voltage for Logic (+5V)
3	VO	Contrast Adjustment
4	RS	Data/Instruction Select
5	R/W	Read/Write Select
6	E	Enable Signal
7-14	DB0-DB7	Data Bus Line

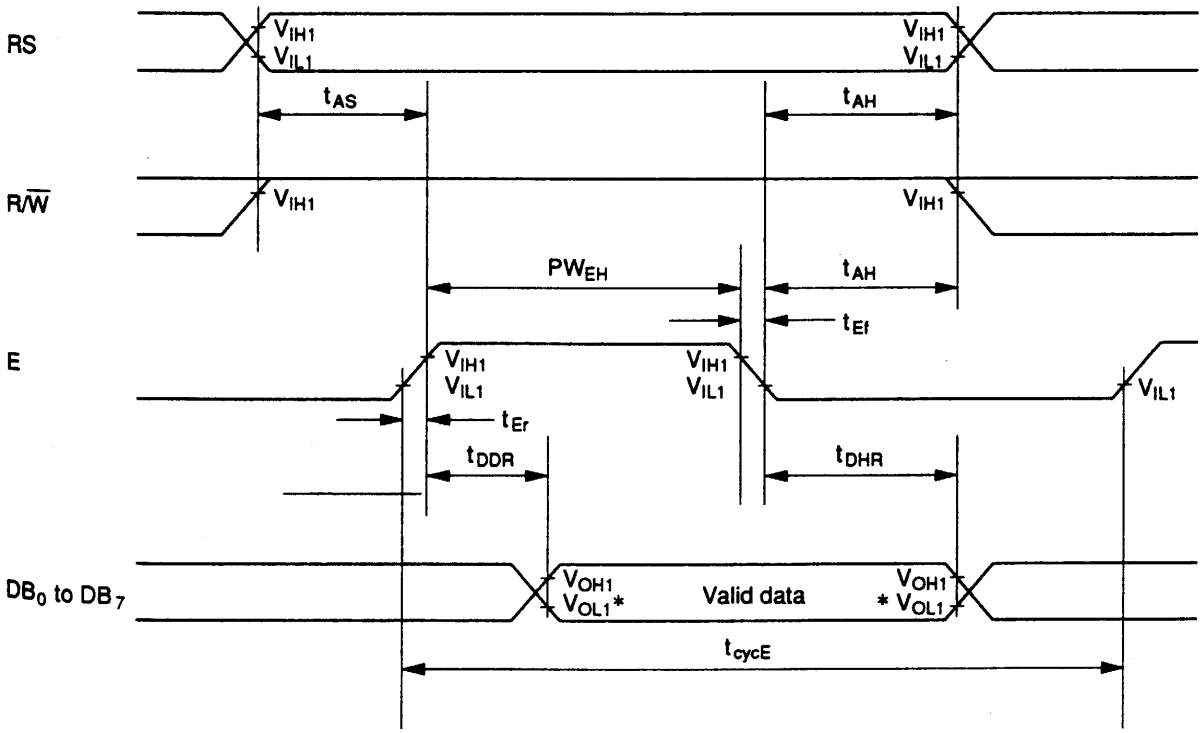
7 TIMING CHARACTERISTICS

Write Operation



Item	Symbol	Min	Typ	Max	Unit
Enable cycle time	tcycE	500	-	-	ns
Enable pulse width (high level)	PWEH	230	-	-	
Enable rise/fall time	tEr,tEf	-	-	20	
Address set-up time (RS, R/W to E)	tAS	40	-	-	
Address hold time	tAH	10	-	-	
Data set-up time	tDSW	80	-	-	
Data hold time	tH	10	-	-	

Read Operation



Item	Symbol	Min	Typ	Max	Unit
Enable cycle time	tcycE	500	-	-	ns
Enable pulse width (high level)	PWEH	230	-	-	
Enable rise/fall time	tEr,tEf	-	-	20	
Address set-up time (RS, R/W to E)	tAS	40	-	-	
Address hold time	tAH	10	-	-	
Data delay time	tDDR	--	-	120	
Data hold time	tDRH	5	-	-	

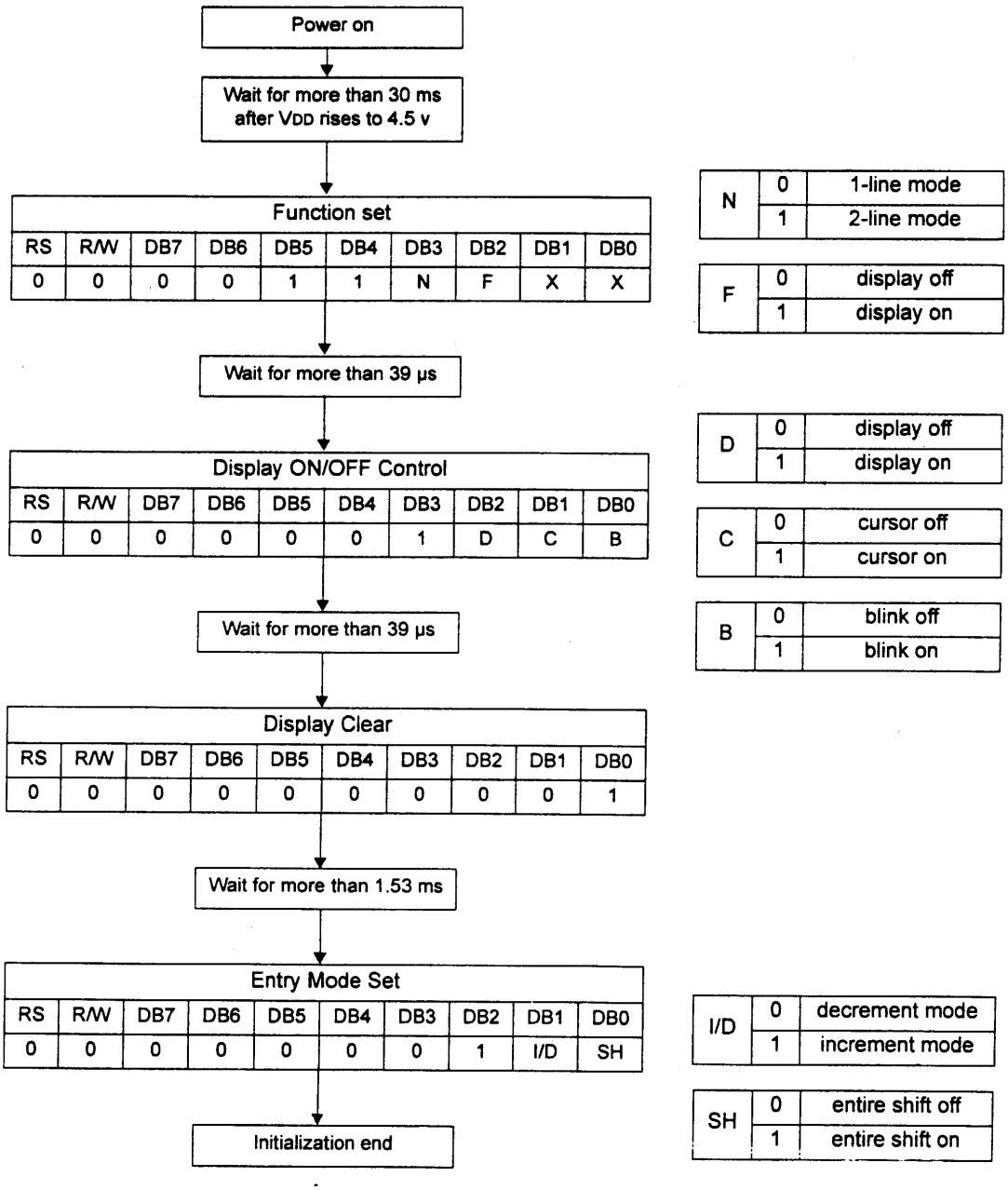
8 INSTRUNTION SET

Instruction	Code										Description	E.T.(fosc =270 KHZ)
	RS	R/W	D7	D6	D5	D4	D3	D2	D1	D0		
Clear Display	0	0	0	0	0	0	0	0	0	1	Write"20H" to DDRAM and set DDRAM address to "00H" from AC	1.53 ms
Return Home	0	0	0	0	0	0	0	0	1	--	Sets DD RAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53 ms
Entry Mode SET	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and enable the shift of entire display.	39 μS
Display ON/OFF Control	0	0	0	0	0	0	1	D	C	B	Set display (D), cursor (C), and blink of cursor (B) on/off control bit.	39 μS
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	--	--	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	39 μS
Function Set	0	0	0	0	1	DL	N	F	--	--	Sets interface data length (DL:8-bit/4-bit), number of display lines (N:2-line/1-line) and , display font type (F:5x11dots/5x8 dost).	39 μS
Set CG RAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Sets CG RAM address in address counter.	39 μS
Set DD RAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Sets DD RAM address in address counter.	39 μS
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 μS
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Writes data into internal RAM (DD RAM /CG RAM).	43 μS
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Reads data from internal RAM (DD RAM /CG RAM).	43 μS

* "—" : don't care

Note : When an MPU program with checking the Busy Flag(DB7) is made, it must be necesssary1/2Fosc is necessary for executing the next instruction by the falling edge of the 'E' signal after the Busy Flag(DB7) goes to "LOW".

9 INITIALIZATION SEQUENCE



10 DD RAM ADDRESS

CHAR.	1	2	3	…	22	23	24
1 LINE	00	01	02	…	15	16	17
2 LINE	40	41	42	…	55	56	57

11 Font Table

Upper 4bit / Lower 4bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	HHHH
LLLL	CG RAM (1)															
LLLH	(2)															
LLHL	(3)															
LLHH	(4)															
LHLL	(5)															
LHLH	(6)															
LHHL	(7)															
LHHH	(8)															
HLLL	(1)															
HLLH	(2)															
HLHL	(3)															
HLHH	(4)															
HHLL	(5)															
HHLH	(6)															
HHHL	(7)															
HHHH	(8)															

12 QUALITY AND RELIABILITY

12.1 TEST CONDITIONS

Tests should be conducted under the following conditions：

Ambient temperature ： 25±5°C

Humidity ： 60±25% RH.

12.2 SAMPLING PLAN

Sampling method shall be in accordance with MIL-STD-105E , level II, normal single sampling plan .

12.3 ACCEPTABLE QUALITY LEVEL

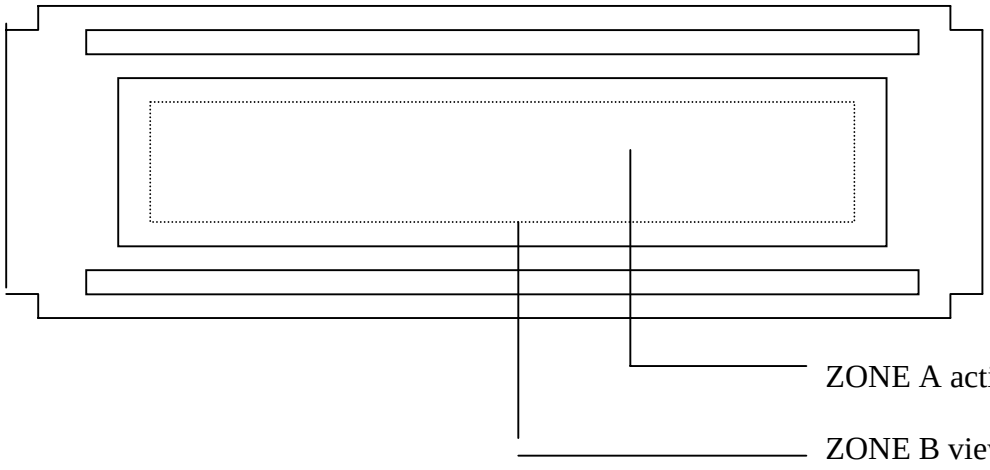
A major defect is defined as one that could cause failure to or materially reduce the usability of the unit for its intended purpose. A minor defect is one that does not materially reduce the usability of the unit for its intended purpose or is an infringement from established standards and has no significant bearing on its effective use or operation.

12.4 APPEARANCE

An appearance test should be conducted by human sight at approximately 30 cm distance from the LCD module under flourescent light. The inspection area of LCD panel shall be within the range of following limits.

12.5 INSPECTION QUALITY CRITERIA

Item	Description of defects			Class of Defects	Acceptable level (%)
Function	Short circuit or Pattern cut			Major	0.65
Dimension	Deviation from drawings			Major	1.5
Black spots	Ave . dia . D	area A	area B	Minor	2.5
	D≦0.2	Disregard			
	0.2<D≦0.3	3	4		
	0.3<D≦0.4	2	3		
	0.4<D	0	1		
Black lines	Width W, Length L	A	B	Minor	2.5
	W≦0.03	disregard			
	0.03<W≦0.05	3	4		
	0.05<W≦0.07 , L≦3.0	1	1		
	See line criteria				
Bubbles in polarizer	Average diameter D 0.2 < D < 0.5 mm for N = 4 , D > 0.5 for N = 1			Minor	2.5
Color uniformity	Rainbow color or newton ring.			Minor	2.5
Glass Scratches	Obvious visible damage.			Minor	2.5
Contrast ratio	See note 1			Minor	2.5
Response time	See note 2			Minor	2.5
Viewing angle	See note 3			Minor	2.5



12.6 RELIABILITY

12.7 RELIABILITY

Test Item	Test Conditions	Note
High Temperature Operation	50±3°C , t=96 hrs	
Low Temperature Operation	0±3°C , t=96 hrs	
High Temperature Storage	70±3°C , t=96 hrs	1,2
Low Temperature Storage	-20±3°C , t=96 hrs	1,2
Temperature Cycle	-20°C ~ 25°C ~ 70°C 30 m in. 5 min. 30 min. (1 cycle) Total 5 cycle	1,2
Humidity Test	40 °C, Humidity 90%, 96 hrs	1,2
Vibration Test (Packing)	Sweep frequency : 10 ~ 55 ~ 10 Hz/1min Amplitude : 0.75mm Test direction : X.Y.Z/3 axis Duration : 30min/each axis	2

Note 1 : Condensation of water is not permitted on the module.

Note 2 : The module should be inspected after 1 hour storage in normal conditions (15-35°C , 45-65%RH).

Definitions of life end point :

- Current drain should be smaller than the specific value.
- Function of the module should be maintained.
- Appearance and display quality should not have degraded noticeably.
- Contrast ratio should be greater than 50% of the initial value.

13 HANDLING PRECAUTIONS

(1) A LCD module is a fragile item and should not be subjected to strong mechanical shocks.

(2) Avoid applying pressure to the module surface. This will distort the glass and cause a change in color.

(3) Under no circumstances should the position of the bezel tabs or their shape be modified.

(4) Do not modify the display PCB in either shape or positioning of components.

(5) Do not modify or move location of the zebra or heat seal connectors.

(6) The device should only be soldered to during interfacing. Modification to other areas of the board should not be carried out.

(7) In the event of LCD breakage and resultant leakage of fluid do not inhale, ingest or make contact with the skin. If contact is made rinse immediately.

(8) When cleaning the module use a soft damp cloth with a mild solvent, such as Isopropyl or Ethyl alcohol. The use of water, ketone or aromatic is not permitted.

(9) Prior to initial power up input signals should not be applied.

(10) Protect the module against static electricity and observe appropriate anti-static precautions.

14 OUTLINE DIMENSION

